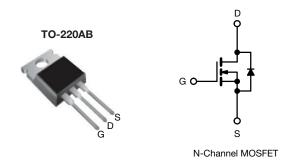
# SiHP21N60EF



**Vishay Siliconix** 

# **EF Series Power MOSFET With Fast Body Diode**



PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650			
R <sub>DS(on)</sub> max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.176		
Q <sub>g</sub> (Max.) (nC)	84			
Q <sub>gs</sub> (nC)	14			
Q <sub>gd</sub> (nC)	24			
Configuration	Single			

### **FEATURES**

- Fast body diode MOSFET using E series technology
- Reduced t<sub>rr</sub>, Q<sub>rr</sub>, and I<sub>RRM</sub>
- Low figure-of-merit (FOM): Ron x Qg
- Low input capacitance (Ciss)
- Increased robustness due to low Q<sub>rr</sub>
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

## **APPLICATIONS**

- Telecommunications
  - Server and telecom power supplies
- Lighting
  - High intensity discharge (HID)
  - Light emitting diodes (LEDs)
- Consumer and computing
  - ATX power supplies
- Industrial
  - Welding
  - Battery chargers
- Renewable energy
- Solar (PV inverters)
- Switch mode power suppliers (SMPS)
- Applications using the following topologies
  - LLC
  - Phase shifted bridge (ZVS)
  - 3-level inverter
  - AC/DC bridge

# **ORDERING INFORMATION**

Package TO-220AB			
Lead (Ph) free and helegen free	SiHP21N60EF-BE3 <sup>a</sup>		
Lead (Pb)-free and halogen-free	SiHP21N60EF-GE3		

#### Note

a. "-BE3" denotes alternate manufacturing location

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V <sub>DS</sub>	600	V
Gate-source voltage			V <sub>GS</sub>	± 30	
Continuous drain current ( $T_J$ = 150 °C)	V <sub>GS</sub> at 10 V T <sub>C</sub>	= 25 °C = 100 °C	- I <sub>D</sub> -	21	A
	V <sub>GS</sub> at 10 V T <sub>C</sub>	= 100 °C		14	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	53	1
Linear derating factor				1.8	W/°C
Single pulse avalanche energy b			E <sub>AS</sub>	367	mJ
Maximum power dissipation			PD	227	W
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-source voltage slope	T <sub>J</sub> = 125 °C	0		70	V/ns
Reverse diode dV/dt <sup>d</sup>			dV/dt	50	v/ns
Soldering recommendations (peak temperature) <sup>c</sup>	For 10 s			300	°C

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD} = 50$  V, starting  $T_J = 25$  °C, L = 28.2 mH,  $R_g = 25 \Omega$ ,  $I_{AS} = 5.1$  A

- c. 1.6 mm from case
- d.  $I_{SD} \leq I_D$ , dI/dt = 900 A/µs, starting  $T_J$  = 25 °C

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COMPLIANT

HALOGEN

FREE



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R <sub>thJA</sub>	-	62	°C/W	
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	0.55		

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static					•	•	
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	600	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	-	0.59	-	V/°C	
Gate-source threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$			4.0	V
Gate-source leakage	I <sub>GSS</sub>	$V_{GS} = \pm 20 V$		-	-	± 100	nA
			$V_{\rm GS}$ = ± 30 V	-	-	± 1	μA
Zava gata valtaga drain avvent	1	V <sub>DS</sub> =	$V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	1	
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = 480 V	, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	500	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 11 A	-	0.153	0.176	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 30 V, I <sub>D</sub> = 11 A		-	7	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	2030	-	pF
Output capacitance	C <sub>oss</sub>			-	105	-	
Reverse transfer capacitance	C <sub>rss</sub>			-	5	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{GS}$ = 0 V, $V_{DS}$ = 0 V to 480 V		-	86	-	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	299	-	
Total gate charge	Q <sub>q</sub>			-	56	84	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	V <sub>GS</sub> = 10 V I <sub>D</sub> = 11 A, V <sub>DS</sub> = 480 V		14	-	nC
Gate-drain charge	Q <sub>gd</sub>			-	24	-	1
Turn-on delay time	t <sub>d(on)</sub>			-	21	42	
Rise time	t <sub>r</sub>	$V_{DD} = 480 \text{ V}, \text{ I}_{D} = 11 \text{ A}$ $\text{R}_{g} = 9.1 \Omega, \text{ V}_{\text{GS}} = 10 \text{ V}$		-	31	62	- ns
Turn-off delay time	t <sub>d(off)</sub>			-	59	89	
Fall time	t <sub>f</sub>				27	54	
Gate input resistance	R <sub>g</sub>	f = 1 MHz, open drain		0.2	0.56	1.2	Ω
Drain-Source Body Diode Characteristic	cs				•	•	•
Continuous source-drain diode current	١ <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	21	- A
Pulsed diode forward current	I <sub>SM</sub>			-	-	53	
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 11 A, V <sub>GS</sub> = 0 V		-	0.9	1.2	V
Reverse recovery time	t <sub>rr</sub>	$T_J = 25 ^{\circ}C, I_F = I_S = 11 A,$ dl/dt = 100 A/µs, V <sub>B</sub> = 400 V		-	135	270	ns
Reverse recovery charge	Q <sub>rr</sub>			-	0.76	1.52	μC
Reverse recovery current	I <sub>RRM</sub>		$v_{\rm R} = 400 v$	-	11	-	A

### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ 



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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

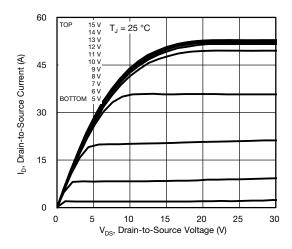


Fig. 1 - Typical Output Characteristics, T<sub>J</sub> = 25 °C

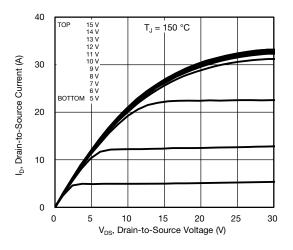


Fig. 2 - Typical Output Characteristics,  $T_J$  = 150 °C

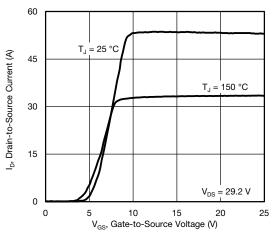


Fig. 3 - Typical Transfer Characteristics

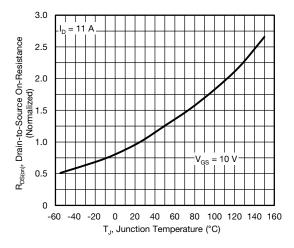


Fig. 4 - Normalized On-Resistance vs. Temperature

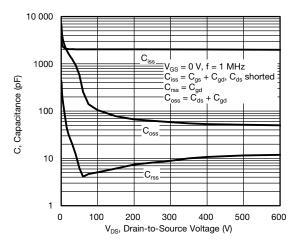
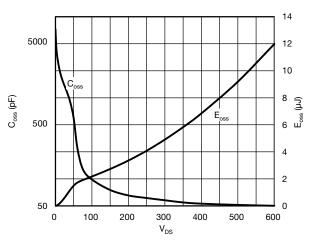
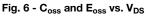


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





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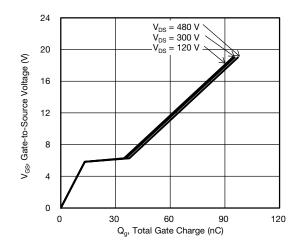


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

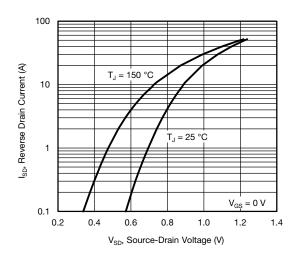


Fig. 8 - Typical Source-Drain Diode Forward Voltage

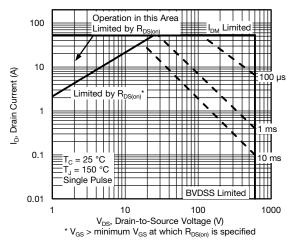


Fig. 9 - Maximum Safe Operating Area

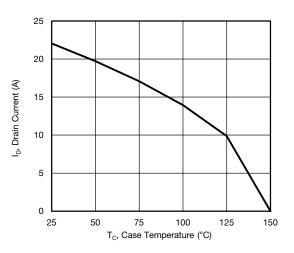


Fig. 10 - Maximum Drain Current vs. Case Temperature

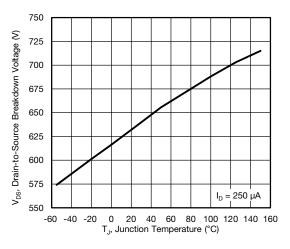


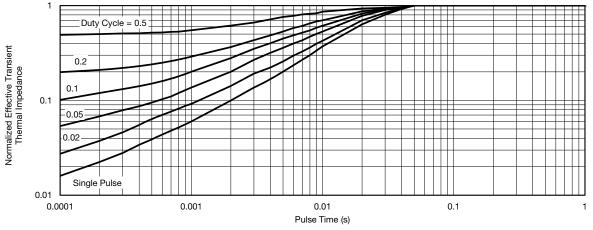
Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature

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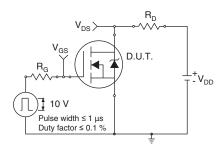


Fig. 13 - Switching Time Test Circuit

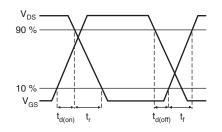


Fig. 14 - Switching Time Waveforms

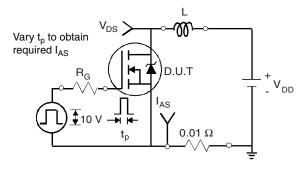
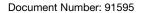


Fig. 15 - Unclamped Inductive Test Circuit

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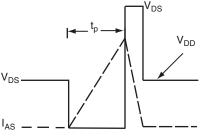


Fig. 16 - Unclamped Inductive Waveforms

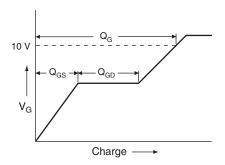
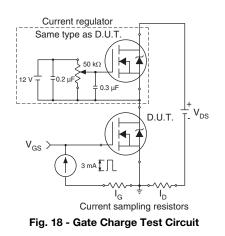


Fig. 17 - Basic Gate Charge Waveform





### Peak Diode Recovery dV/dt Test Circuit

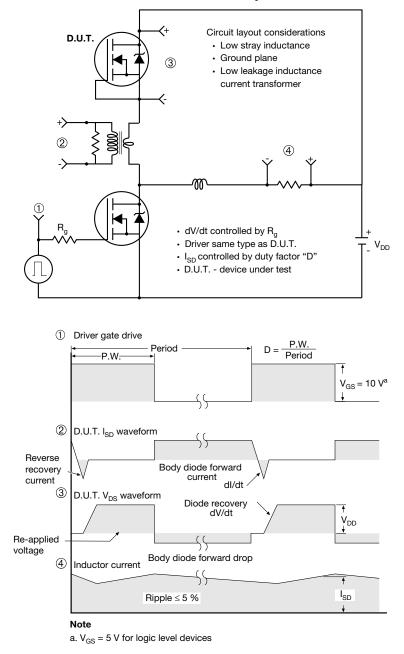


Fig. 19 - For N-Channel

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